



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Scott D. Maurer

Title:

ARCHITECTURAL MOLDING

Serial No.:

09/337,243

Filed:

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Docket:

30349

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.97 and 1.98, Applicant is submitting herewith Form PTO-1449 listing references for consideration by the Examiner. Also submitted herewith is a legible copy of each reference. The undersigned hereby certifies that each item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

Respectfully submitted,

PEARNE & GORDON LLP

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Ву____

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Date: 9-28-0

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on the date indicated below.

John P. Murtaugh

Name of Attorney for Applicant(s)

9-18-00 John & Muntaugh

Date

Signature of Attorney